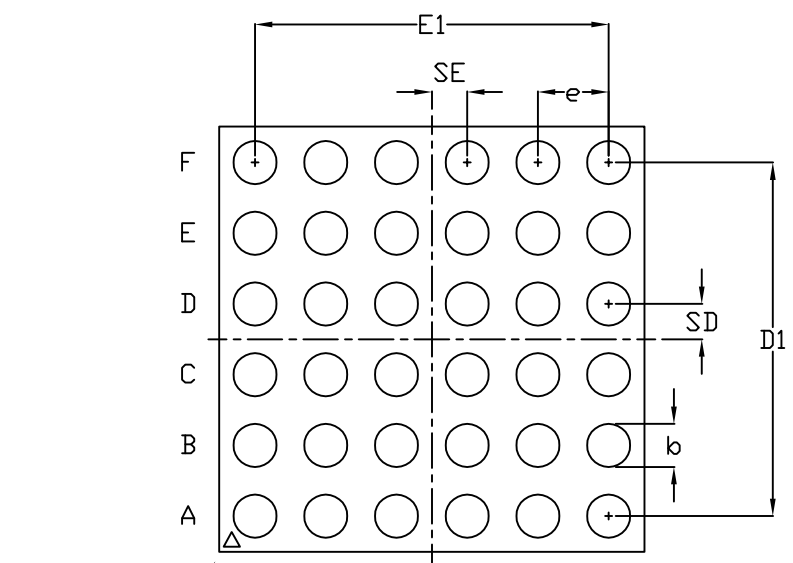
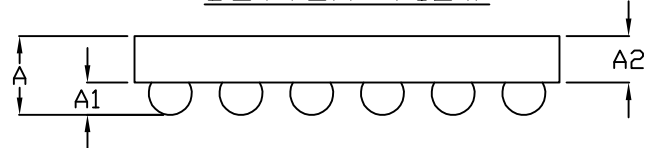


TOP VIEW



BOTTOM VIEW



SIDE VIEW

COMMON DIMENSIONS	
A	0.62±0.05-0.08
A1	0.29±0.02
A2	0.33 REF.
b	∅0.35±0.03
D	3.06±0.10
D1	2.50 BASIC
E	3.06±0.10
E1	2.50 BASIC
e	0.50 BASIC
SD	0.25 BASIC
SE	0.25 BASIC

PKG. CODE	DEPOPULATED SOLDER BALLS
B36-1	NONE
B36-2	B3, B4, E3, E4
B36-3	B4, B5, C3, C4, C5, D3, D4, D5, E4, E5
B36-4	C3, C4, D3, D4

NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.
2. MATERIAL MUST COMPLY WITH BANNED AND RESTRICTED SUBSTANCES SPEC # 10-0131.
3. PRODUCT MARKING: NUMBER OF CHARACTERS AND LINES VARY PER PRODUCT
4. ALL DIMENSIONS APPLY TO BOTH LEAD FREE (+) & LEADED (-) PKG. CODES.
5. PACKAGE CODE: B36-1, B36-2
B36-3, B36-4

-DRAWING NOT TO SCALE-

MAXIM			
TITLE: PACKAGE OUTLINE, 36 BUMPS, UCSP, 3.06x3.06x.062mm, 0.5mm PITCH			
APPROVAL	DOCUMENT CONTROL NO. 21-0082	REV. L	1/1